HCS-T MICRO 1 C 1 1 7035 - Electronics housing

2203125

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Handheld housing, T-Micro, light gray, consisting of two half shells, two front plates with screws, front 1.1 mm recessed, closed

Your advantages

- · Suitable for handheld devices
- Easy integration of LCD displays and membrane keypads
- · Ergonomic straight or staggered housing design
- · Fast mounting, thanks to the modular design

Commercial data

Item number	2203125
Packing unit	1 pc
Minimum order quantity	1 pc
Sales key	AC02
Product key	ACFABA
GTIN	4055626376837
Weight per piece (including packing)	91.6 g
Weight per piece (excluding packing)	64 g
Customs tariff number	84879090
Country of origin	DE

PHŒN

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Technical data

Product properties

Product type	Complete housing
Housing series	HCS
Туре	straight
Housing type	Handheld housing
Ventilation openings present	no
Battery compartment	no

Dimensions

Dimensional drawing	h
Width	48 mm
Height	150 mm
Depth	28 mm
Dimensions	38 mm x 140 mm x 1.1 mm (Recessed area on front)
Front with faceplate	top, 1 x (29.8 mm x 15.8 mm)
	bottom, 1 x (29.8 mm x 15.8 mm)

PCB design

PCB thickness	1.4 mm 1.8 mm
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Material specifications

Color (Housing)	light grey (RAL 7035)
Flammability rating according to UL 94	V0
CTI according to IEC 60112	400 ≤ CTI < 600
Insulating material	II
Surface characteristics	untreated
Housing material	ABS

Environmental and real-life conditions

IEC 60695-2-11:2014-02		
850 °C		
30 s		
Thermal stability / ball thrust test		
IEC 60695-10-2:2014-02		
80 °C		

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gree of protection (IP code) Specification IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08 bient conditions Max. IP code to attain IP54 Ambient temperature (operation) -40 °C 80 °C (depending on power dissipation) -40 °C 55 °C Ambient temperature (assembly) -5 °C 80 °C Relative humidity (storage/transport) 95 % data Number of PCB holders 2	Test duration	1 h
Specification IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08 Inbient conditions IP54 Ambient temperature (operation) -40 °C 80 °C (depending on power dissipation) Ambient temperature (storage/transport) -40 °C 55 °C Ambient temperature (assembly) -5 °C 80 °C Relative humidity (storage/transport) 95 % Aubleor of PCB holders 2	Force	20
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Relative humidity (storage/transport) 95 % B data 2	Ambient temperature (storage/transport)	-40 °C 55 °C
B data Number of PCB holders 2	Ambient temperature (assembly)	-5 °C 80 °C
Number of PCB holders 2	Relative humidity (storage/transport)	95 %
	B data	
Thickness of the PCB 1.4 mm 1.8 mm	Number of PCB holders	2
	Thickness of the PCB	1.4 mm 1.8 mm
	ckaging specifications	
kaging specifications	Type of packaging	Box packaging

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Classifications

ECLASS

	ECLASS-11.0	27182702
	ECLASS-13.0	27190102
ETIM		
	ETIM 9.0	EC001031
UNSPSC		
	UNSPSC 21.0	31261500

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